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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I²C, SCI, SPI, USB OTG
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	46
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 14x12b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51116adfm-3a

1.3 Block Diagram

Figure 1.2 shows a block diagram.

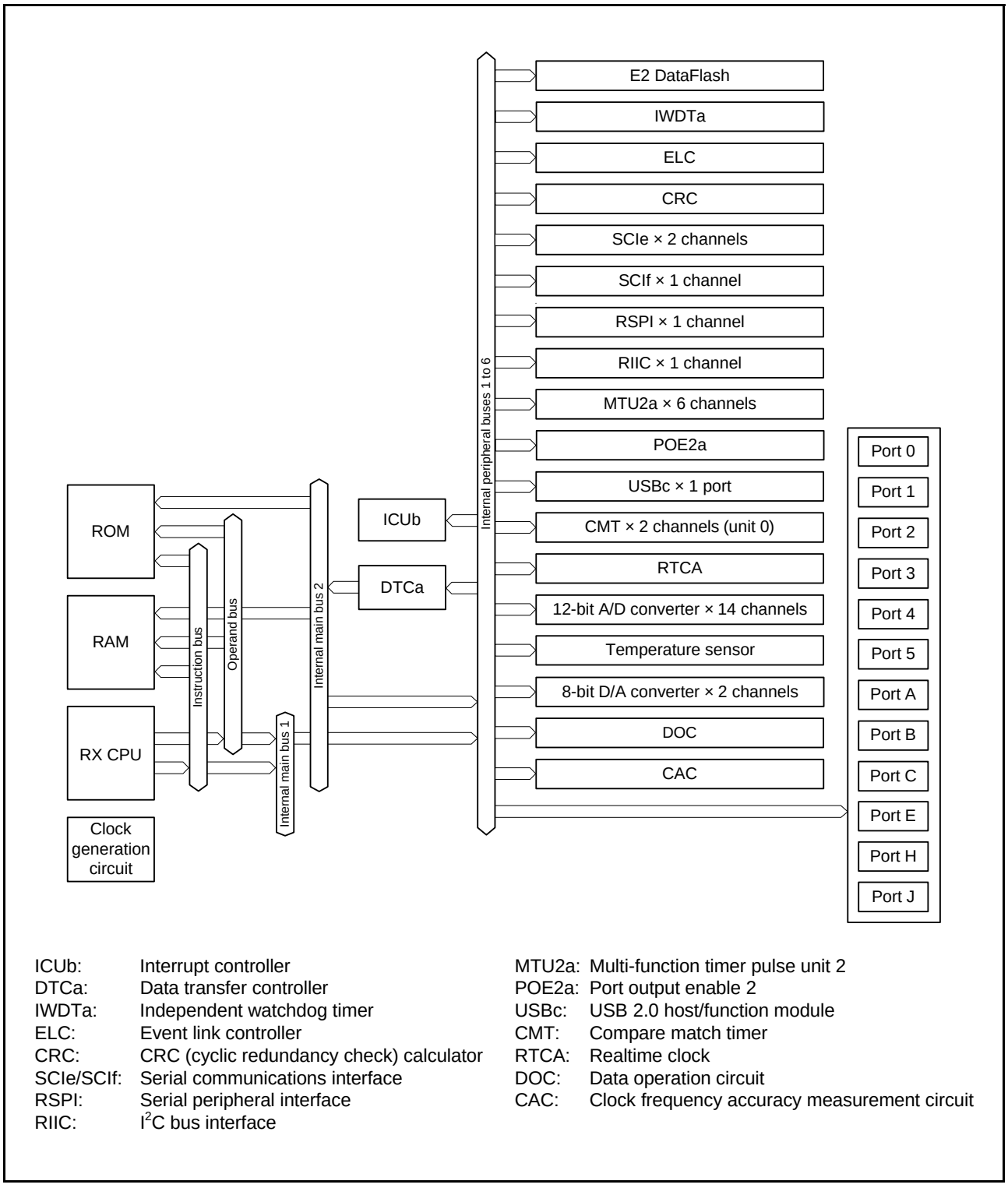
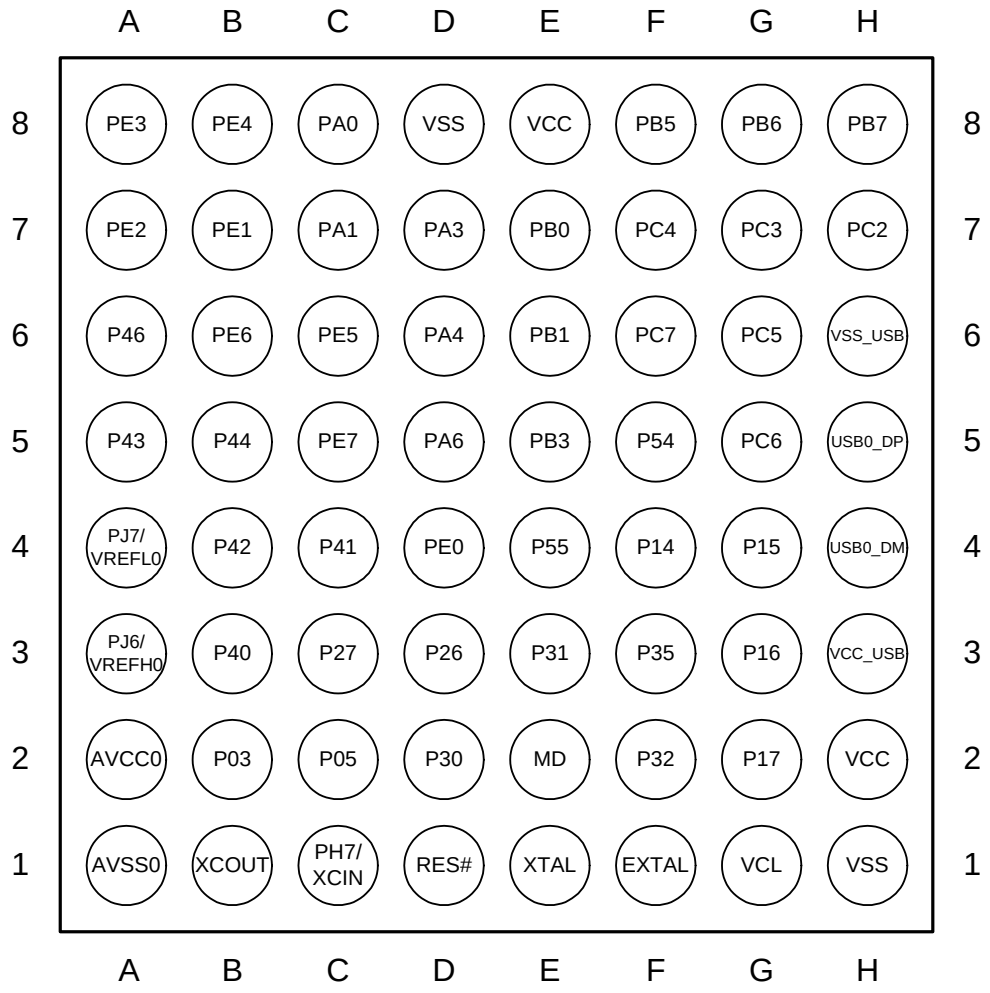


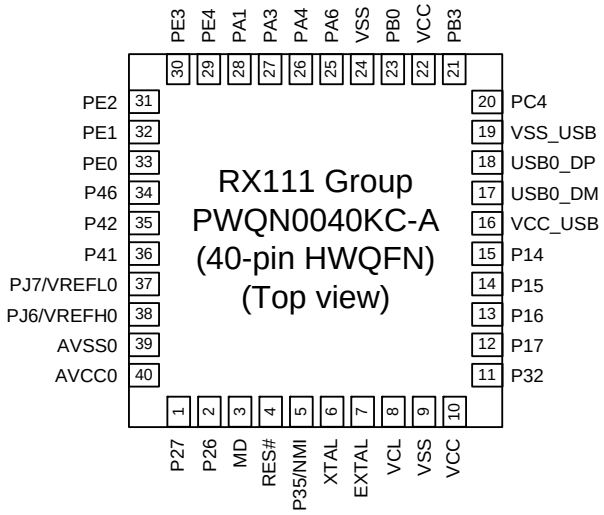
Figure 1.2 Block Diagram

RX111 Group
PWLG0064KA-A
(64-pin WFLGA)
(Upper perspective view)



Note: • This figure indicates the power supply pins and I/O port pins. For the pin configuration, see the table “List of Pins and Pin Functions (64-Pin WFLGA)”.
• For the position of A1 pin in the package, see “Package Dimensions”.

Figure 1.4 Pin Assignments of the 64-Pin WFLGA



Note: • This figure indicates the power supply pins and I/O port pins.
For the pin configuration, see the table “List of Pins and Pin Functions (40-Pin HWQFN)”.
Note: • It is recommended that the exposed die pad of HWQFN should be connected to VSS.

Figure 1.6 Pin Assignments of the 40-Pin HWQFN

Table 1.5 List of Pins and Pin Functions (64-Pin LFQFP/LQFP) (2/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCIe, SCIf, RSPI, RIIC, USB)	Others
42		PA4	MTIC5U/MTCLKA/MTIOC2B	TXD5/SMOSI5/SSDA5/SSLA0	IRQ5
43		PA3	MTIOC0D/MTCLKD/ MTIOC1B/POE0#	RXD5/SMISO5/SSCL5/MISOA	IRQ6
44		PA1	MTIOC0B/MTCLKC/ RTCOUT	SCK5/SSLA2	
45		PA0	MTIOC4A	SSLA1	CACREF
46		PE5	MTIOC4C/MTIOC2B		IRQ5/AN013
47		PE4	MTIOC4D/MTIOC1A/ MTIOC3A	MOSIA	IRQ4/AN012
48		PE3	MTIOC0A/MTIOC1B/ MTIOC4B/POE8#	CTS12#/RTS12#/SS12#/RSPCKA	IRQ3/AN011
49		PE2	MTIOC4A	RXD12/RXDX12/SMISO12/SSCL12	IRQ7/AN010
50		PE1	MTIOC4C	TXD12/TXDX12/SIOX12/SMOSI12/ SSDA12	IRQ1/AN009
51		PE0	MTIOC2A/POE3#	SCK12	IRQ0/AN008
52		PE7			IRQ7/AN015
53		PE6			IRQ6/AN014
54		P46*2			AN006
55		P44*2			AN004
56		P43*2			AN003
57		P42*2			AN002
58		P41*2			AN001
59	VREFL0	PJ7*2			
60		P40*2			AN000
61	VREFH0	PJ6*2			
62	AVSS0				
63	AVCC0				
64		P05			DA1

Note 1. Not 5 V tolerant.
Note 2. The power source of the I/O buffer for these pins is AVCC0.

Table 1.6 List of Pins and Pin Functions (64-Pin WFLGA) (2/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCIe, SCIf, RSPI, RIIC, USB)	Others
F2		P32	MTIOC0C/RTCOUT		IRQ2
F3	UPSEL	P35			NMI
F4	UB#	P14	MTIOC0A/MTIOC3A/ MTCLKA	CTS1#/RTS1#/SS1#/TXD12/ TXDX12/SIOX12/SMOSI12/ SSDA12/SSLA0/USB0_OVRCURA	IRQ4
F5		P54	MTIOC4B		
F6		PC7	MTIOC3A/MTCLKB	TXD1/SMOSI1/SSDA1/MISOA/ USB0_OVRCURB	CACREF
F7		PC4	MTCLKC/MTIOC3D/POE0#	SCK5/SSLA0/USB0_VBUSEN/ USB0_VBUS*1	IRQ2/CLKOUT
F8		PB5	MTIOC1B/MTIOC2A/POE1#		
G1	VCL				
G2		P17	MTIOC0C/MTIOC3A/ MTIOC3B/POE8#	SCK1/MISOA/SDA0/RXD12/ RXDX12/SMISO12/SSCL12	IRQ7
G3		P16	MTIOC3C/MTIOC3D/ RTCOUT	TXD1/SMOSI1/SSDA1/SCL0/ MOSIA/USB0_VBUSEN/ USB0_OVRCURB/USB0_VBUS	IRQ6/ADTRG0#
G4		P15	MTIOC0B/MTCLKB	RXD1/SMISO1/SSCL1/RSPCKA	IRQ5/CLKOUT
G5		PC6	MTIOC3C/MTCLKA	RXD1/SMISO1/SSCL1/MOSIA/ USB0_EXICEN	
G6		PC5	MTIOC3B/MTCLKD	SCK1/RSPCKA/USB0_ID	
G7		PC3	MTIOC4D	TXD5/SMOSI5/SSDA5	
G8		PB6/PC0	MTIOC3D		
H1	VSS				
H2	VCC				
H3	VCC_USB				
H4				USB0_DM	
H5				USB0_DP	
H6	VSS_USB				
H7		PC2	MTIOC4B	RXD5/SMISO5/SSCL5/SSLA3	
H8		PB7/PC1	MTIOC3B		

Note 1. Not 5 V tolerant.
Note 2. The power source of the I/O buffer for these pins is AVCC0.

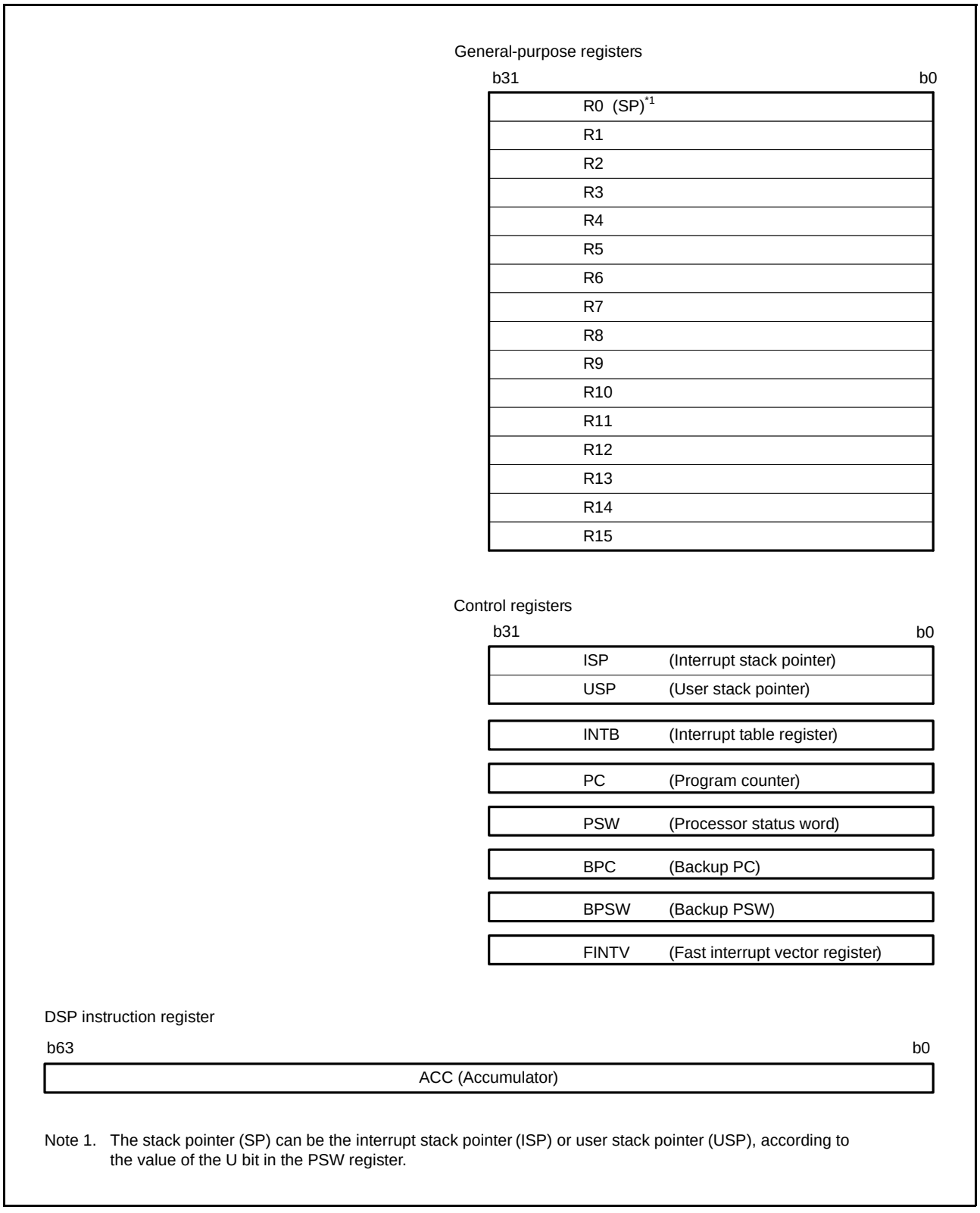
Table 1.8 List of Pins and Pin Functions (40-Pin HWQFN) (2/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCIe, SCIf, RSPI, RIIC, USB)	Others
40	AVCC0				

Note 1. Not 5 V tolerant.
Note 2. The power source of the I/O buffer for these pins is AVCC0.

2. CPU

Figure 2.1 shows the register set of the CPU.



Note 1. The stack pointer (SP) can be the interrupt stack pointer (ISP) or user stack pointer (USP), according to the value of the U bit in the PSW register.

Figure 2.1 Register Set of the CPU

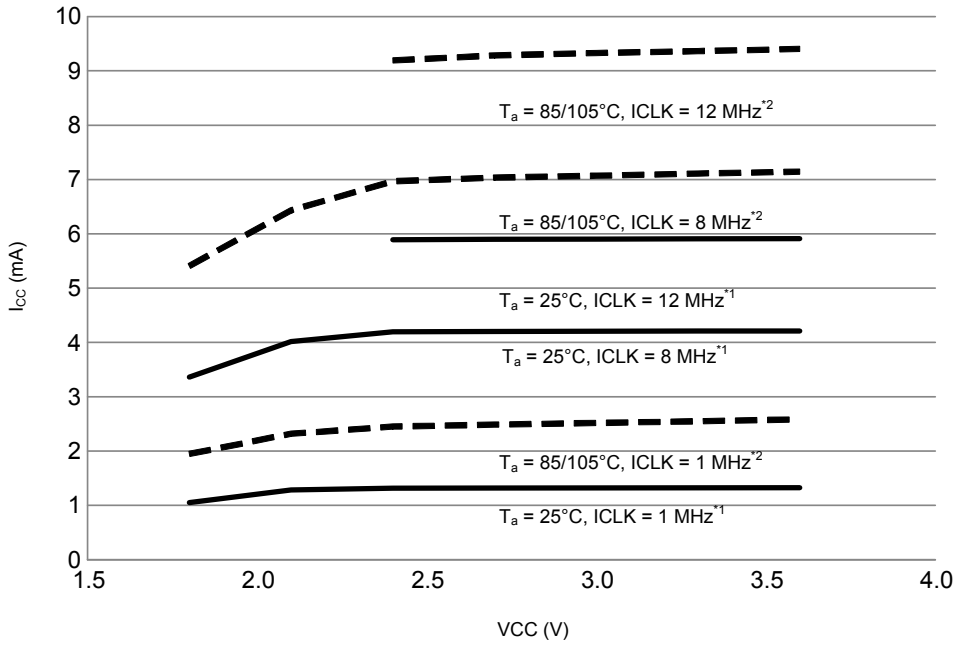
4.1 I/O Register Addresses (Address Order)

Table 4.1 List of I/O Registers (Address Order) (1/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 0000h	SYSTEM	Mode Monitor Register	MDMONR	16	16	3 ICLK
0008 0008h	SYSTEM	System Control Register 1	SYSCR1	16	16	3 ICLK
0008 000Ch	SYSTEM	Standby Control Register	SBYCR	16	16	3 ICLK
0008 0010h	SYSTEM	Module Stop Control Register A	MSTPCRA	32	32	3 ICLK
0008 0014h	SYSTEM	Module Stop Control Register B	MSTPCRB	32	32	3 ICLK
0008 0018h	SYSTEM	Module Stop Control Register C	MSTPCRC	32	32	3 ICLK
0008 0020h	SYSTEM	System Clock Control Register	SCKCR	32	32	3 ICLK
0008 0026h	SYSTEM	System Clock Control Register 3	SCKCR3	16	16	3 ICLK
0008 0028h	SYSTEM	PLL Control Register	PLLCR	16	16	3 ICLK
0008 002Ah	SYSTEM	PLL Control Register 2	PLLCR2	8	8	3 ICLK
0008 0032h	SYSTEM	Main Clock Oscillator Control Register	MOSCCR	8	8	3 ICLK
0008 0033h	SYSTEM	Sub-Clock Oscillator Control Register	SOSCCR	8	8	3 ICLK
0008 0034h	SYSTEM	Low-Speed On-Chip Oscillator Control Register	LOCOCR	8	8	3 ICLK
0008 0035h	SYSTEM	IWDT-Dedicated On-Chip Oscillator Control Register	ILOCOCR	8	8	3 ICLK
0008 0036h	SYSTEM	High-Speed On-Chip Oscillator Control Register	HOCOCR	8	8	3 ICLK
0008 003Ch	SYSTEM	Oscillation Stabilization Flag Register	OSCOVFSR	8	8	3 ICLK
0008 003Eh	SYSTEM	CLKOUT Output Control Register	CKOCR	16	16	3 ICLK
0008 0040h	SYSTEM	Oscillation Stop Detection Control Register	OSTDCR	8	8	3 ICLK
0008 0041h	SYSTEM	Oscillation Stop Detection Status Register	OSTDSR	8	8	3 ICLK
0008 00A0h	SYSTEM	Operating Power Control Register	OPCCR	8	8	3 ICLK
0008 00A1h	SYSTEM	Sleep Mode Return Clock Source Switching Register	RSTCKCR	8	8	3 ICLK
0008 00A2h	SYSTEM	Main Clock Oscillator Wait Control Register	MOSCWTCR	8	8	3 ICLK
0008 00A5h	SYSTEM	High-Speed On-Chip Oscillator Wait Control Register	HOCOWTCR	8	8	3 ICLK
0008 00AAh	SYSTEM	Sub Operating Power Control Register	SOPCCR	8	8	3 ICLK
0008 00C0h	SYSTEM	Reset Status Register 2	RSTSR2	8	8	3 ICLK
0008 00C2h	SYSTEM	Software Reset Register	SWRR	16	16	3 ICLK
0008 00E0h	SYSTEM	Voltage Monitoring 1 Circuit Control Register 1	LVD1CR1	8	8	3 ICLK
0008 00E1h	SYSTEM	Voltage Monitoring 1 Circuit Status Register	LVD1SR	8	8	3 ICLK
0008 00E2h	SYSTEM	Voltage Monitoring 2 Circuit Control Register 1	LVD2CR1	8	8	3 ICLK
0008 00E3h	SYSTEM	Voltage Monitoring 2 Circuit Status Register	LVD2SR	8	8	3 ICLK
0008 03FEh	SYSTEM	Protect Register	PRCR	16	16	3 ICLK
0008 1300h	BSC	Bus Error Status Clear Register	BERCLR	8	8	2 ICLK
0008 1304h	BSC	Bus Error Monitoring Enable Register	BEREN	8	8	2 ICLK
0008 1308h	BSC	Bus Error Status Register 1	BERSR1	8	8	2 ICLK
0008 130Ah	BSC	Bus Error Status Register 2	BERSR2	16	16	2 ICLK
0008 1310h	BSC	Bus Priority Control Register	BUSPRI	16	16	2 ICLK
0008 2400h	DTC	DTC Control Register	DTCCR	8	8	2 ICLK
0008 2404h	DTC	DTC Vector Base Register	DTCVBR	32	32	2 ICLK
0008 2408h	DTC	DTC Address Mode Register	DTCADMOD	8	8	2 ICLK
0008 240Ch	DTC	DTC Module Start Register	DTCST	8	8	2 ICLK
0008 240Eh	DTC	DTC Status Register	DTCSTS	16	16	2 ICLK
0008 7010h	ICU	Interrupt Request Register 016	IR016	8	8	2 ICLK
0008 701Bh	ICU	Interrupt Request Register 027	IR027	8	8	2 ICLK
0008 701Ch	ICU	Interrupt Request Register 028	IR028	8	8	2 ICLK
0008 701Dh	ICU	Interrupt Request Register 029	IR029	8	8	2 ICLK
0008 7020h	ICU	Interrupt Request Register 032	IR032	8	8	2 ICLK
0008 7021h	ICU	Interrupt Request Register 033	IR033	8	8	2 ICLK
0008 7022h	ICU	Interrupt Request Register 034	IR034	8	8	2 ICLK
0008 7024h	ICU	Interrupt Request Register 036	IR036	8	8	2 ICLK
0008 7025h	ICU	Interrupt Request Register 037	IR037	8	8	2 ICLK

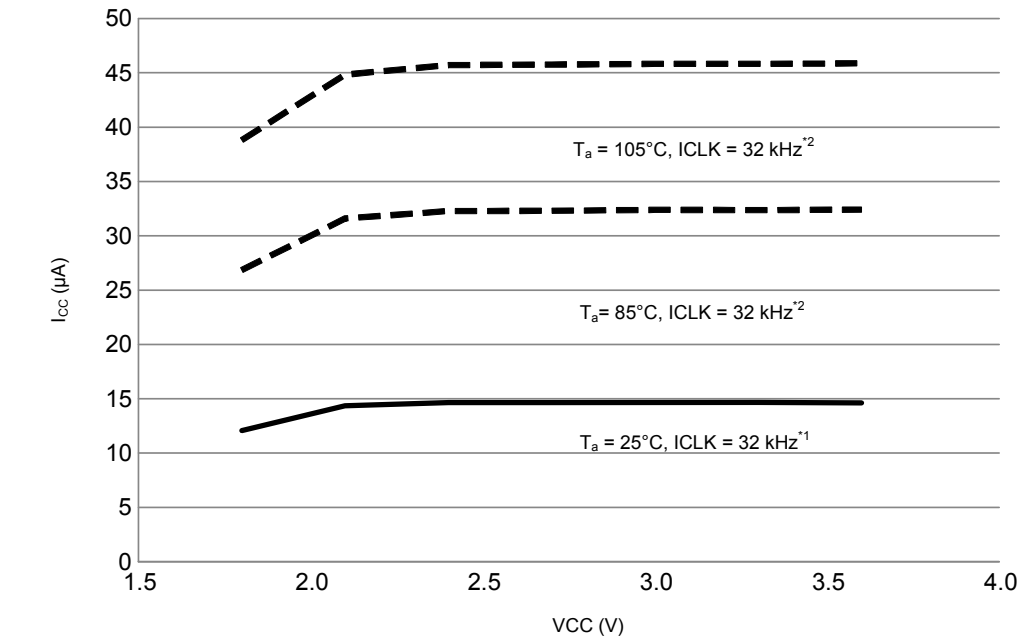
Table 4.1 List of I/O Registers (Address Order) (12/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 C023h	PORT3	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C024h	PORT4	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C025h	PORT5	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C02Ah	PORTA	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C02Bh	PORTB	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C02Ch	PORTC	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C02Eh	PORTE	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C032h	PORTJ	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C040h	PORT0	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C041h	PORT1	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C042h	PORT2	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C043h	PORT3	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C044h	PORT4	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C045h	PORT5	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C04Ah	PORTA	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C04Bh	PORTB	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C04Ch	PORTC	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C04Eh	PORTE	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C051h	PORTH	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C052h	PORTJ	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C060h	PORT0	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C061h	PORT1	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C062h	PORT2	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C063h	PORT3	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C064h	PORT4	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C065h	PORT5	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C06Ah	PORTA	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C06Bh	PORTB	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C06Ch	PORTC	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C06Eh	PORTE	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C071h	PORTH	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C072h	PORTJ	Port Mode Register	PMR	8	8	2 or 3 PCLKB



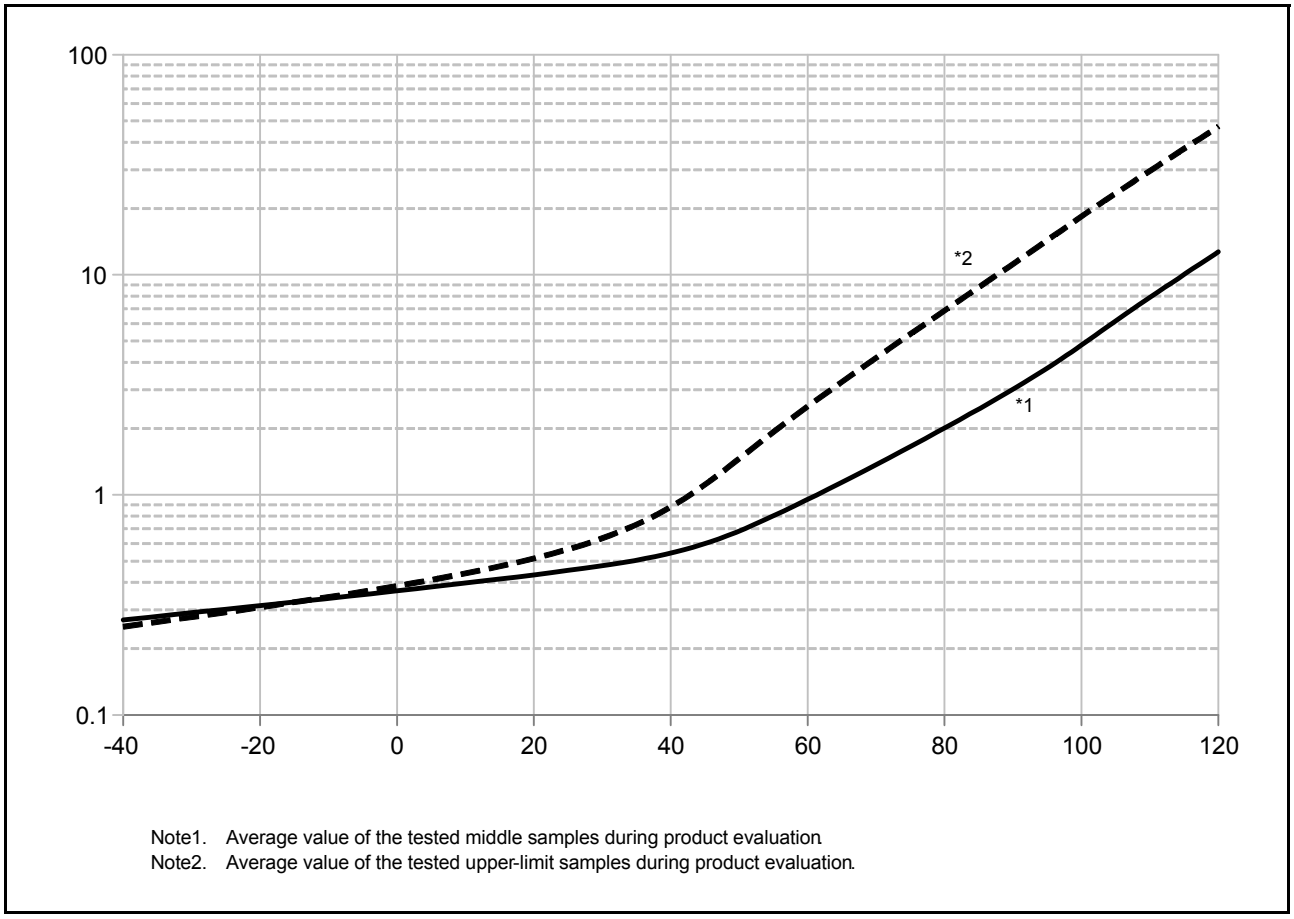
Note 1. All peripheral operation is normal.
Average value of the tested middle samples during product evaluation.
Note 2. All peripheral operation is maximum.
Average value of the tested upper-limit samples during product evaluation.

Figure 5.5 Voltage Dependency in Middle-Speed Operating Mode (Reference Data)



Note 1. All peripheral operation is normal.
Average value of the tested middle samples during product evaluation.
Note 2. All peripheral operation is maximum.
Average value of the tested upper-limit samples during product evaluation.

Figure 5.6 Voltage Dependency in Low-Speed Operating Mode (Reference Data)



Note1. Average value of the tested middle samples during product evaluation.
Note2. Average value of the tested upper-limit samples during product evaluation.

Figure 5.10 Temperature Dependency in Software Standby Mode (Reference Data)

Table 5.11 DC Characteristics (9)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V

Item	Symbol	Typ.	Max.	Unit	Test Conditions
Permissible total consumption power*1	Pd	—	300	mW	D version (T_a = -40 to 85°C)
		—	105		G version (T_a = -40 to 105°C)*2

Note 1. Total power dissipated by the entire chip (including output currents).
Note 2. Please contact Renesas Electronics sales office for derating under T_a = +85°C to 105°C. Derating is the systematic reduction of load for the sake of improved reliability.

5.2.1 Standard I/O Pin Output Characteristics (1)

Figure 5.12 to Figure 5.15 show the characteristics of general ports (except for the RIIC output pin, ports P40 to P44, P46, ports PJ6, PJ7)

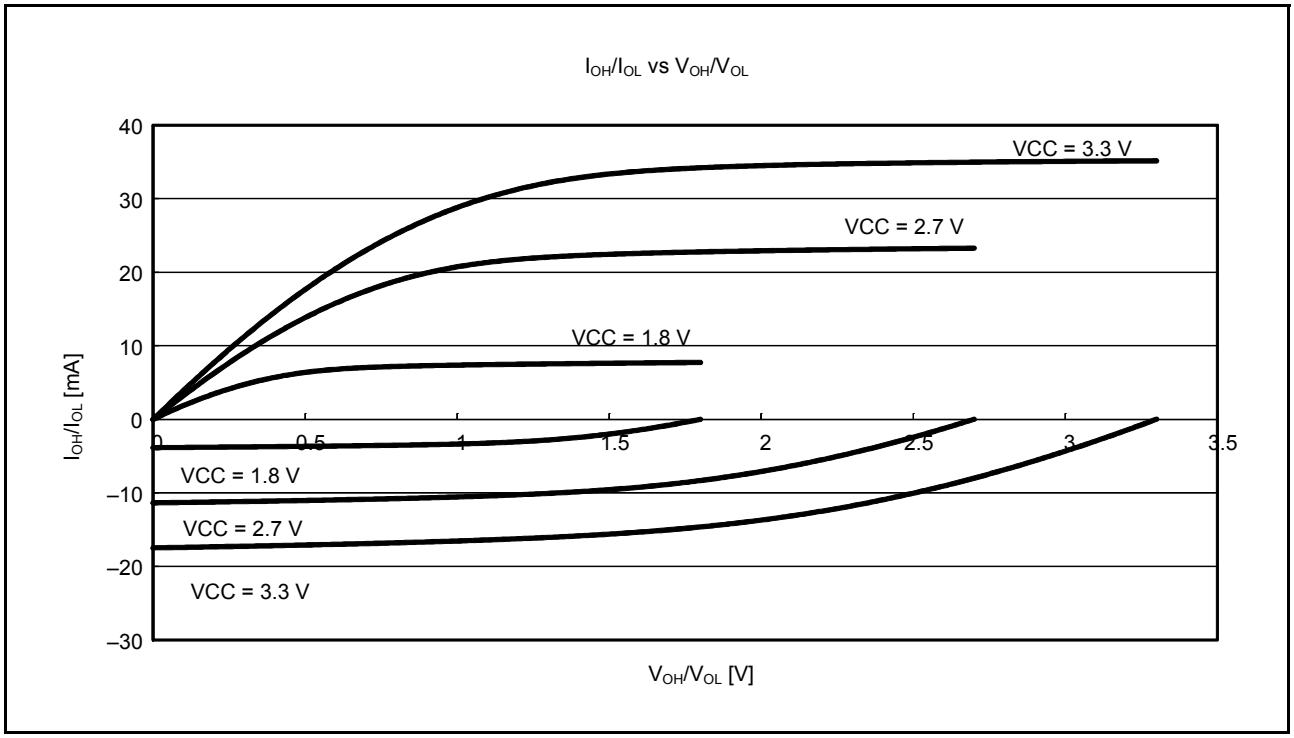


Figure 5.12 V_{OH}/V_{OL} and I_{OH}/I_{OL} Voltage Characteristics of General Ports (Except for the RIIC Output Pin, Ports P40 to P44, P46, Ports PJ6, PJ7) at T_a = 25°C (Reference Data)

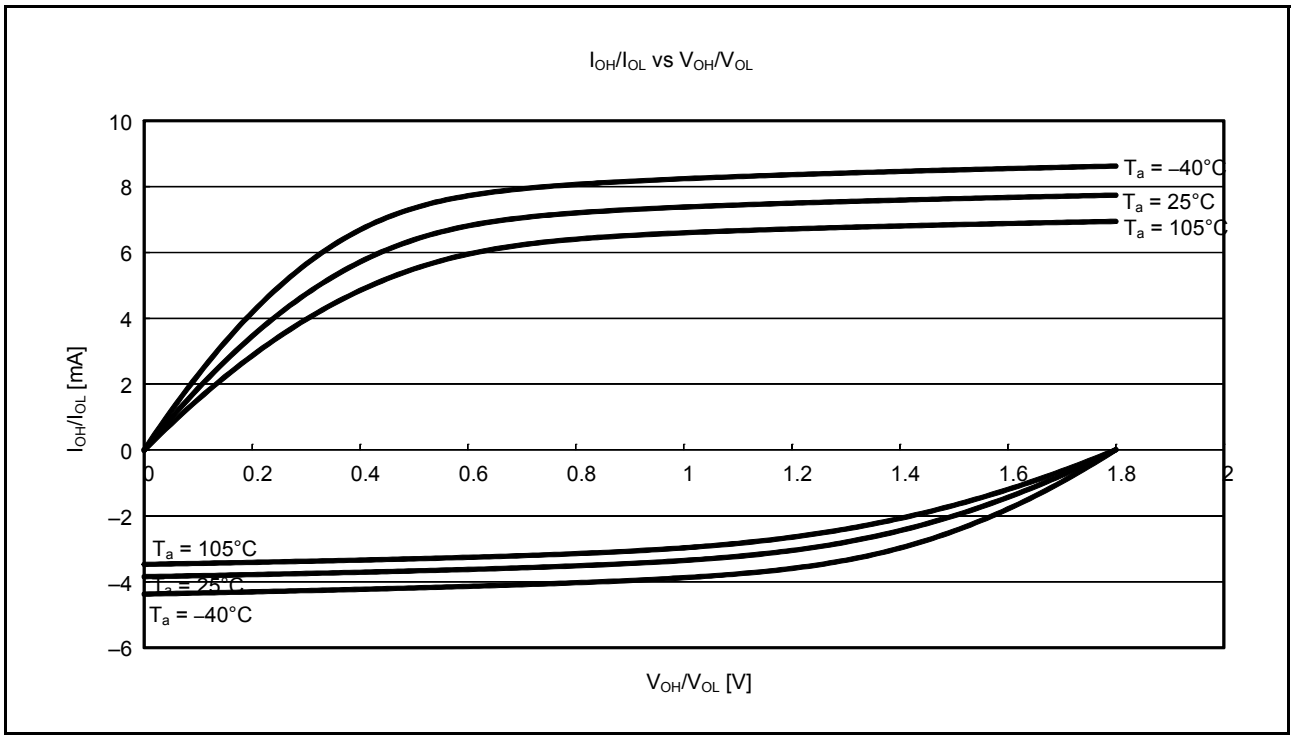


Figure 5.13 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics of General Ports (Except for the RIIC Output Pin, Ports P40 to P44, P46, Ports PJ6, PJ7) at VCC = 1.8 V (Reference Data)

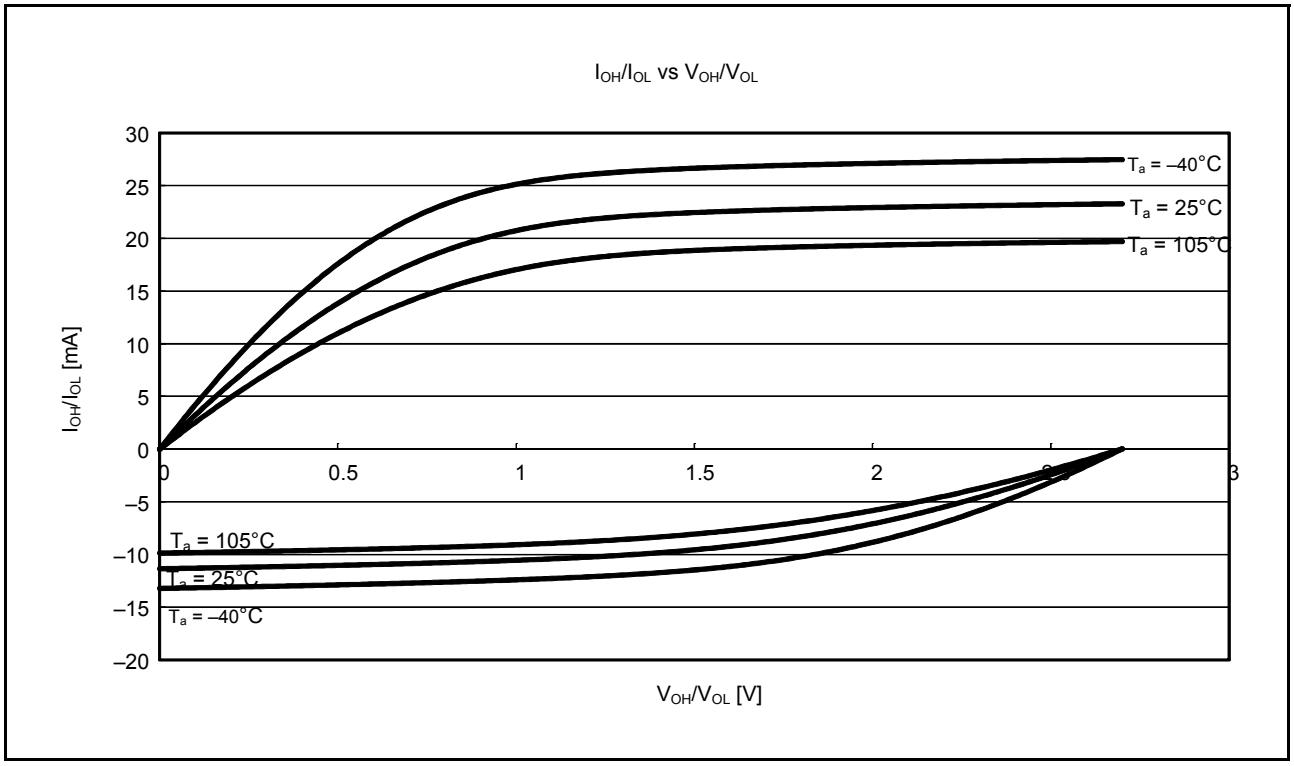


Figure 5.14 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics of General Ports (Except for the RIIC Output Pin, Ports P40 to P44, P46, Ports PJ6, PJ7) at VCC = 2.7 V (Reference Data)

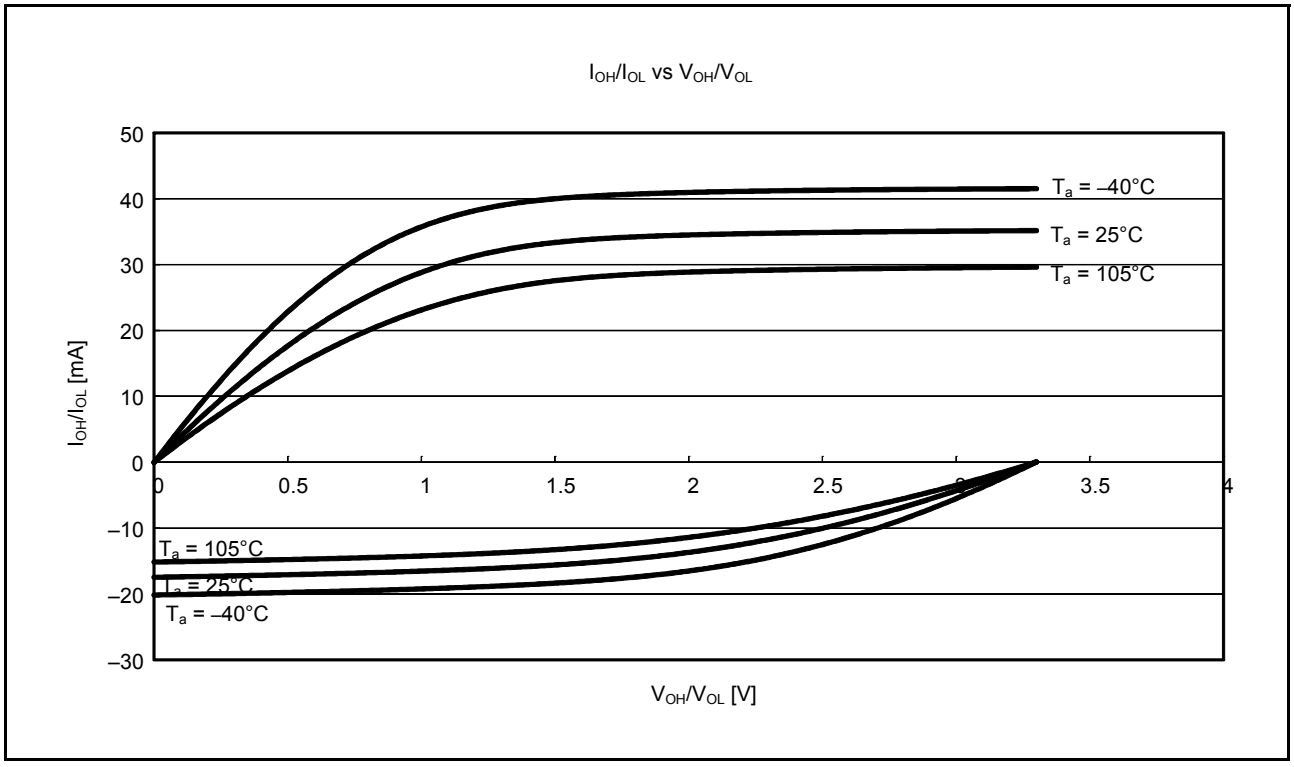


Figure 5.15 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics of General Ports (Except for the RIIC Output Pin, Ports P40 to P44, P46, Ports PJ6, PJ7) at VCC = 3.3 V (Reference Data)

5.3.4 Control Signal Timing

Table 5.31 Control Signal Timing

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
NMI pulse width	t_{NMIW}	200	—	—	ns	NMI digital filter disabled (NMIFLTE.NFLTEN = 0)	t_{Pcyc} × 2 ≤ 200 ns
		t_{Pcyc} × 2*1	—	—			t_{Pcyc} × 2 > 200 ns
		200	—	—		NMI digital filter enabled (NMIFLTE.NFLTEN = 1)	t_{NMICK} × 3 ≤ 200 ns
		t_{NMICK} × 3.5*2	—	—			t_{NMICK} × 3 > 200 ns
IRQ pulse width	t_{IRQW}	200	—	—	ns	IRQ digital filter disabled (IRQFLTE0.FLTENi = 0)	t_{Pcyc} × 2 ≤ 200 ns
		t_{Pcyc} × 2*1	—	—			t_{Pcyc} × 2 > 200 ns
		200	—	—		IRQ digital filter enabled (IRQFLTE0.FLTENi = 1)	t_{IRQCK} × 3 ≤ 200 ns
		t_{IRQCK} × 3.5*3	—	—			t_{IRQCK} × 3 > 200 ns

Note: • 200 ns minimum in software standby mode.
Note 1. t_{Pcyc} indicates the cycle of PCLKB.
Note 2. t_{NMICK} indicates the cycle of the NMI digital filter sampling clock.
Note 3. t_{IRQCK} indicates the cycle of the IRQi digital filter sampling clock (i = 0 to 7).

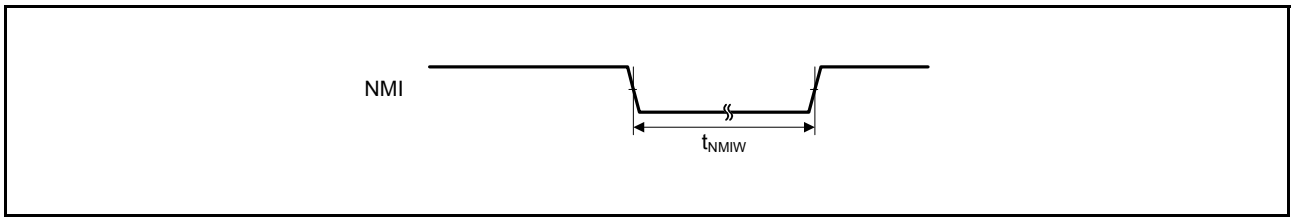


Figure 5.36 NMI Interrupt Input Timing

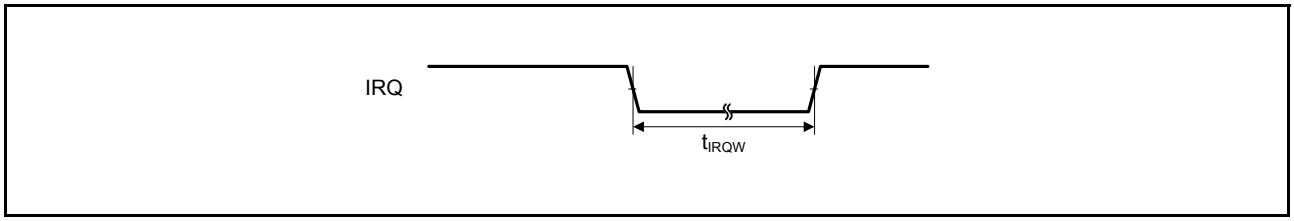


Figure 5.37 IRQ Interrupt Input Timing

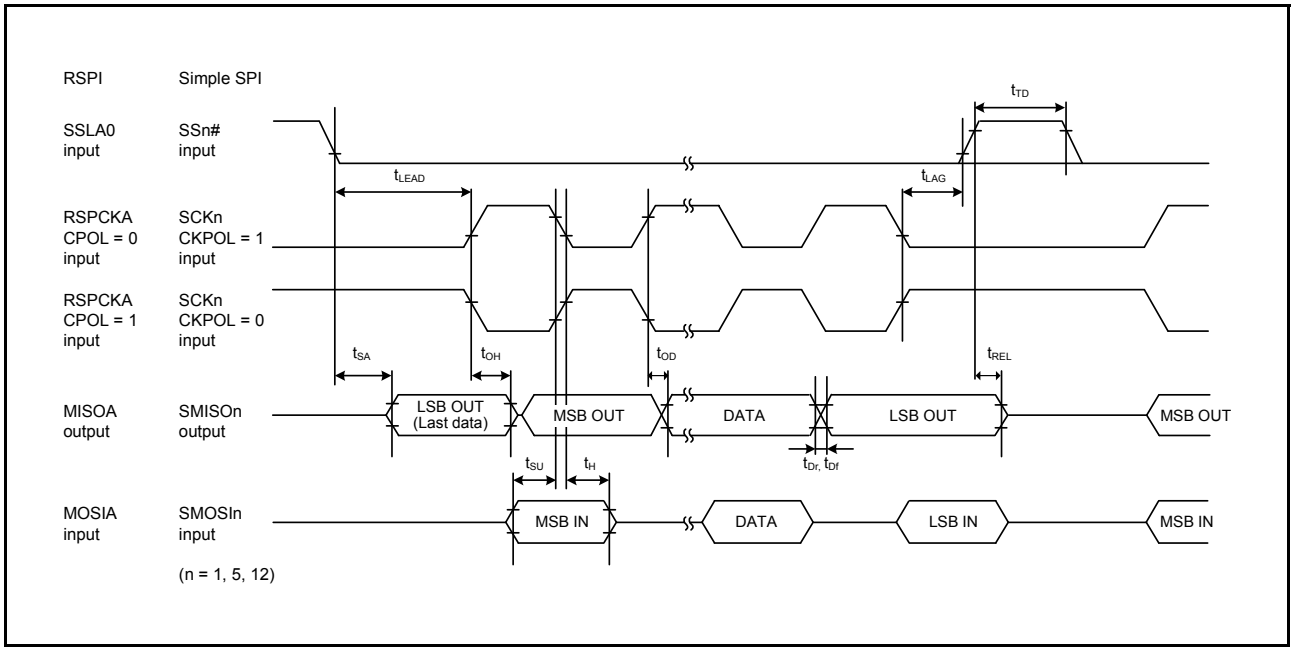
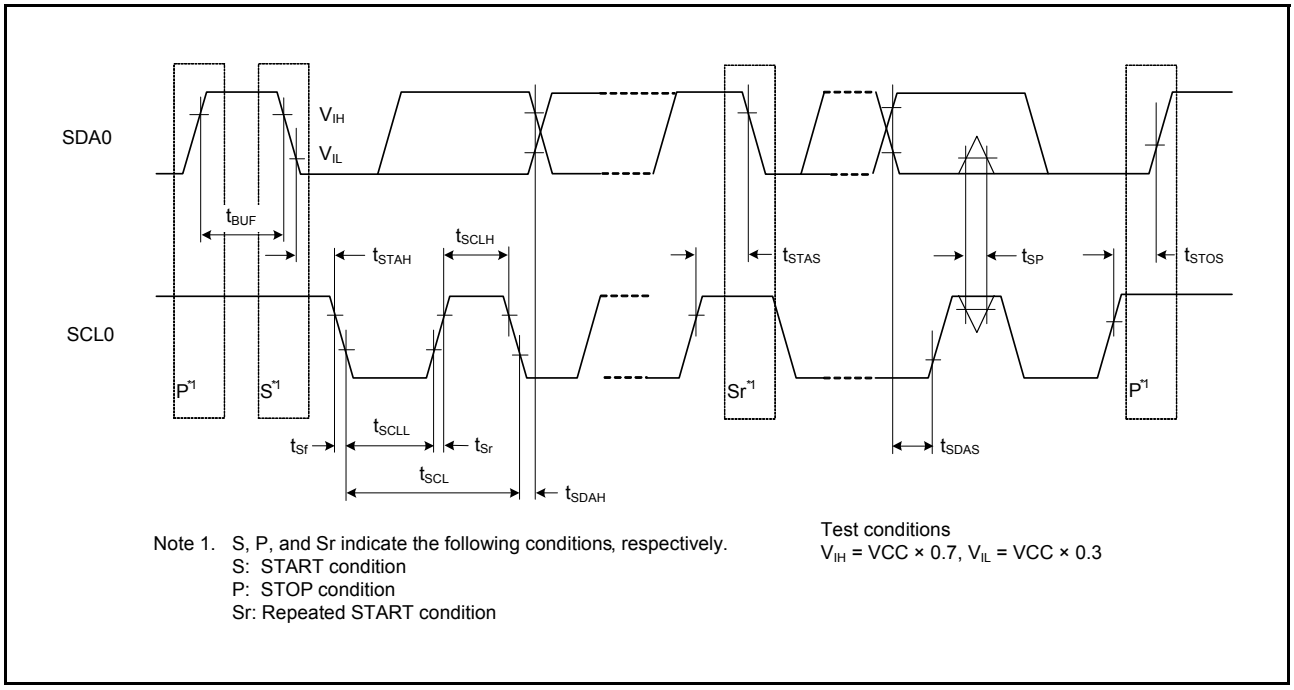


Figure 5.52 RSPI Timing (Slave, CPHA = 1) and Simple SPI Timing (Slave, CKPH = 0)



Note 1. S, P, and Sr indicate the following conditions, respectively.
S: START condition
P: STOP condition
Sr: Repeated START condition

Test conditions
V_{IH} = VCC × 0.7, V_{IL} = VCC × 0.3

Figure 5.53 RIIC Bus Interface Input/Output Timing and Simple I²C Bus Interface Input/Output Timing

5.6 D/A Conversion Characteristics

Table 5.43 D/A Conversion Characteristics

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, fPCLKB ≤ 32 MHz, T_a = –40 to +105°C

Item		Min.	Typ.	Max.	Unit	Test Conditions
Resolution		—	—	8	Bit	
Conversion time	VCC = 2.7 to 3.6 V	—	—	3.0	µs	35-pF capacitive load
	VCC = 1.6 to 2.7 V	—	—	6.0		
Absolute accuracy	VCC = 2.4 to 3.6 V	—	—	±3.0	LSB	2-MΩ resistive load
	VCC = 1.8 to 2.4 V	—	—	±3.5		
	VCC = 2.4 to 3.6 V	—	—	±2.0	LSB	4-MΩ resistive load
	VCC = 1.8 to 2.4 V	—	—	±2.5		
RO output resistance		—	6.4	—	kΩ	

5.7 Temperature Sensor Characteristics

Table 5.44 Temperature Sensor Characteristics

Conditions: 2.0 V ≤ VCC = VCC_USB ≤ 3.6 V, 2.0 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Relative accuracy	—	—	±1.5	—	°C	2.4 V or above
		—	±2.0	—		Below 2.4 V
Temperature slope	—	—	–3.65	—	mV/°C	
Output voltage (at 25°C)	—	—	1.05	—	V	VCC = 3.3 V
Temperature sensor start time	t_{START}	—	—	5	µs	
Sampling time	—	5	—	—	µs	

5.9 Oscillation Stop Detection Timing

Table 5.47 Oscillation Stop Detection Circuit Characteristics

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Detection time	t_{dr}	—	—	1	ms	Figure 5.62

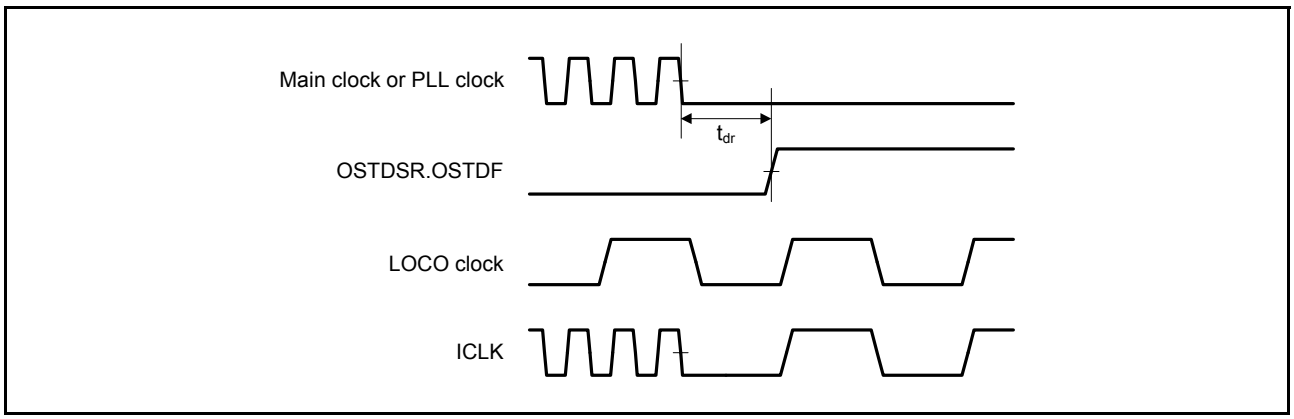
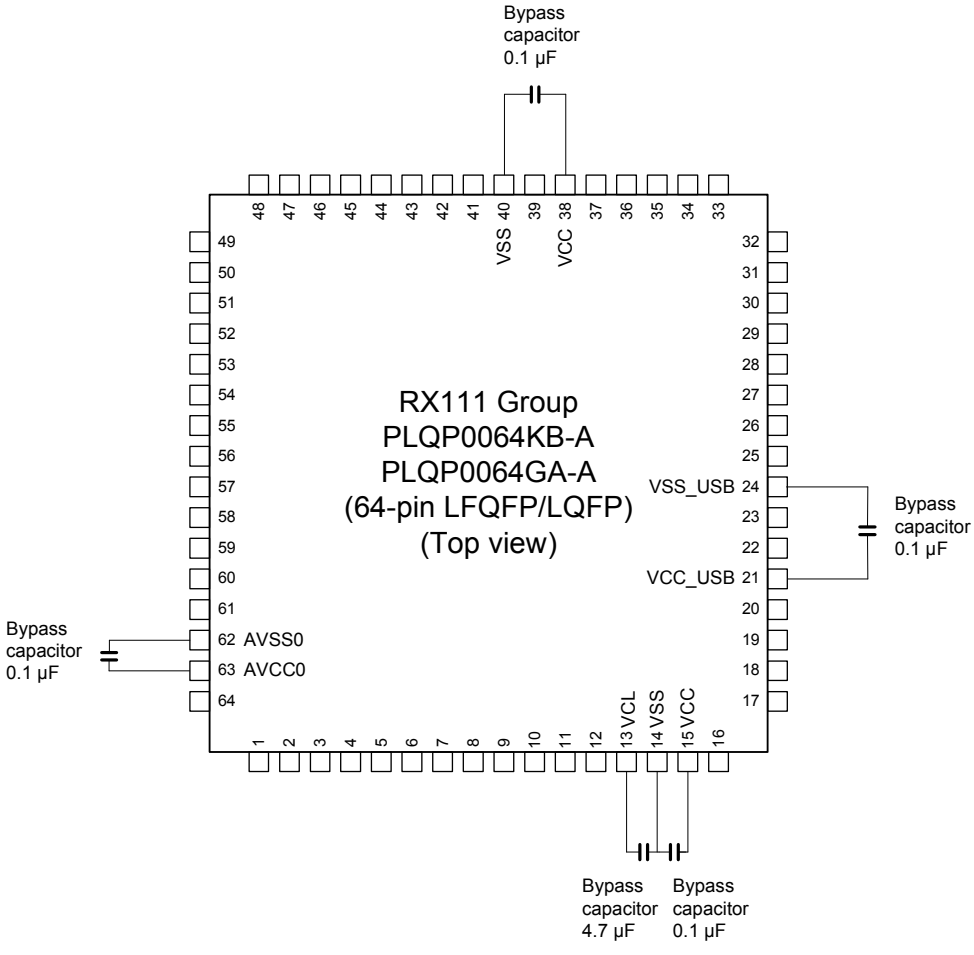


Figure 5.62 Oscillation Stop Detection Timing

5.12 Usage Notes

5.12.1 Connecting VCL Capacitor and Bypass Capacitors

This MCU integrates an internal voltage-down circuit, which is used for lowering the power supply voltage in the internal MCU to adjust automatically to the optimum level. A 4.7-µF capacitor needs to be connected between this internal voltage-down power supply (VCL pin) and VSS pin. Figure 5.63 to Figure 5.64 shows how to connect external capacitors. Place an external capacitor close to the pins. Do not apply the power supply voltage to the VCL pin. Insert a multilayer ceramic capacitor as a bypass capacitor between each pair of the power supply pins. Implement a bypass capacitor to the MCU power supply pins as close as possible. Use a recommended value of 0.1 µF as the capacitance of the capacitors. For the capacitors related to crystal oscillation, see section 9, Clock Generation Circuit in the User's Manual: Hardware. For the capacitors related to analog modules, also see section 30, 12-Bit A/D Converter (S12ADb) in the User's Manual: Hardware.
For notes on designing the printed circuit board, see the descriptions of the application note "Hardware Design Guide" (R01AN1411EJ). The latest version can be downloaded from Renesas Electronics Website.



Note. Do not apply the power supply voltage to the VCL pin.
Use a 4.7-µF multilayer ceramic for the VCL pin and place it close to the pin.
A recommended value is shown for the capacitance of the bypass capacitors.

Figure 5.63 Connecting Capacitors (64 Pins)

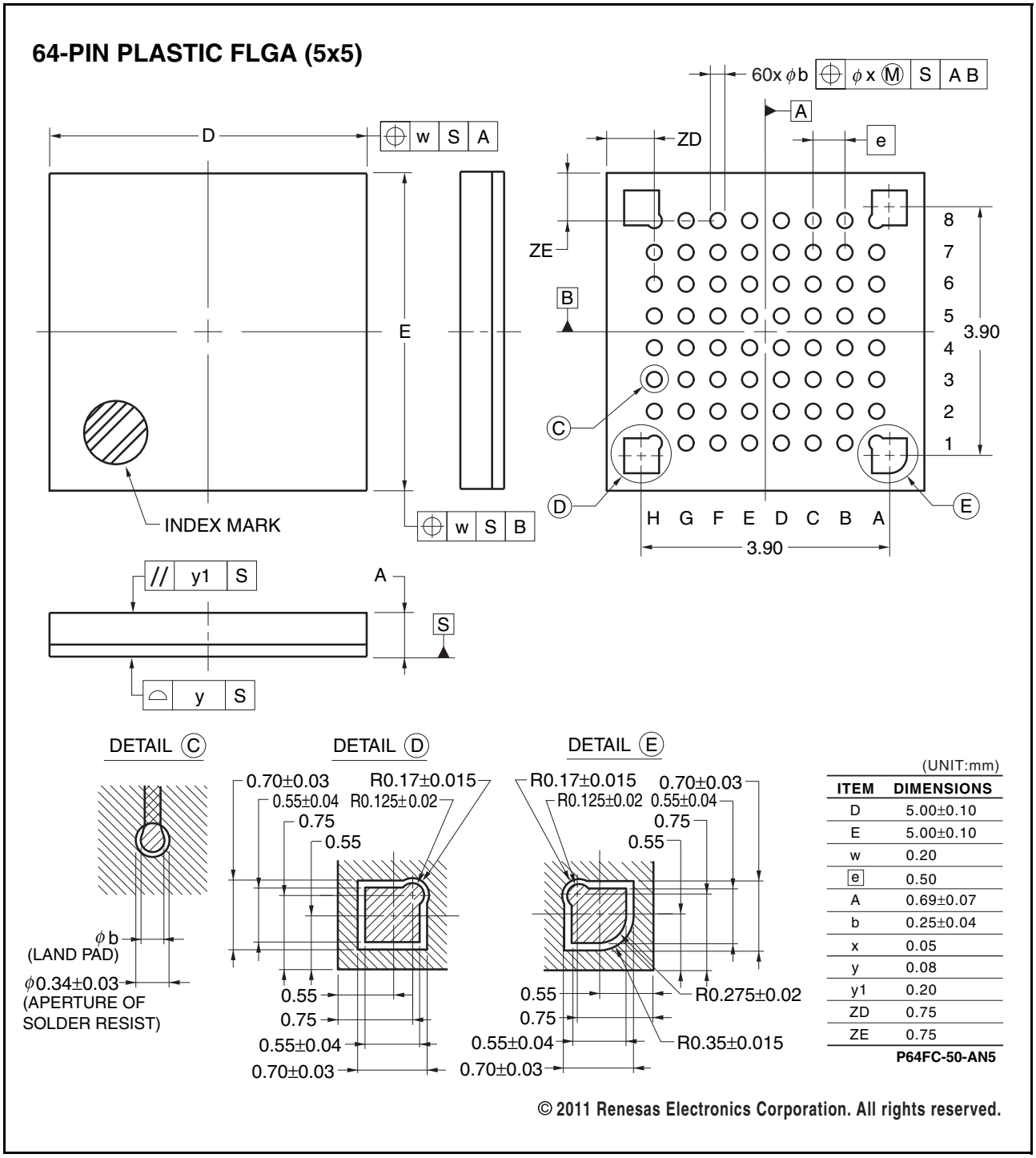


Figure C 64-Pin WFLGA (PWLG0064KA-A)

Rev.	Date	Description	
		Page	Summary
1.20	Sep 29, 2014	85	Figure 5.41 RSPI Clock Timing and Simple SPI Clock Timing, Figure 5.42 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Set to Division Ratio Other Than Divided by 2) and Simple SPI Timing (Master, CKPH = 1) changed
		86	Figure 5.43 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Set to Divided by 2) added, Figure 5.44 RSPI Timing (Master, CPHA = 1) (Bit Rate: PCLKB Set to Division Ratio Other Than Divided by 2) and Simple SPI Timing (Master, CKPH = 0) changed
		87	Figure 5.45 RSPI Timing (Master, CPHA = 1) (Bit Rate: PCLKB Set to Divided by 2) added, Figure 5.46 RSPI Timing (Slave, CPHA = 0) and Simple SPI Timing (Slave, CKPH = 1) changed
		88	Figure 5.47 RSPI Timing (Slave, CPHA = 1) and Simple SPI Timing (Slave, CKPH = 0) changed
		89	Table 5.37 USB Characteristics (USB0_DP and USB0_DM Pin Characteristics) and Figure 5.49 USB0_DP and USB0_DM Output Timing, changed
		90	Figure 5.50 Test Circuit, changed
		91	Table 5.38 A/D Conversion Characteristics (1), Figure 5.51 AVCC0 to AVREFH0 Voltage Range, changed
		92	Table 5.39 A/D Conversion Characteristics (2), Table 5.40 A/D Conversion Characteristics (3) changed
		101	Table 5.49 ROM (Flash Memory for Code Storage) Characteristics (2) and Table 5.50 ROM (Flash Memory for Code Storage) Characteristics (3), changed
		102	Table 5.52 E2 DataFlash Characteristics (2), Table 5.53 E2 DataFlash Characteristics (3) changed
1.21	Dec 09, 2014	1. Overview	
		2 to 4	Table 1.1 Outline of Specifications Unique ID, changed
		5. Electrical Characteristics	
		51	Table 5.3 DC Characteristics (1) and Table 5.4 DC Characteristics (2), changed
		61	Table 5.19 Output Voltage (1) and Table 5.20 Output Voltage (2), changed
		102	Table 5.52 E2 DataFlash Characteristics (2): high-speed operating mode and Table 5.53 E2 DataFlash Characteristics (3): middle-speed operating mode, changed